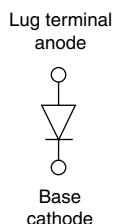


# HEXFRED® Ultrafast Soft Recovery Diode, 180 A


**HALF-PAK (D-67)**


## FEATURES

- Very low  $Q_{rr}$  and  $t_{rr}$
- Lead (Pb)-free
- Designed and qualified for industrial level

## BENEFITS

- Reduced RFI and EMI
- Reduced snubbing

## DESCRIPTION

HEXFRED® diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and  $di/dt$  simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.


**RoHS**  
COMPLIANT

## PRODUCT SUMMARY

$I_{F(AV)}$	180 A
$V_R$	400 V
$I_{F(DC)}$ at $T_C$	200 A at 100 °C

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	$V_R$		400	V
Continuous forward current	$I_F$	$T_C = 25\text{ °C}$	395	A
		$T_C = 100\text{ °C}$	200	
Single pulse forward current	$I_{FSM}$	Limited by junction temperature	1200	
Non-repetitive avalanche energy	$E_{AS}$	$L = 100\text{ }\mu\text{H}$ , duty cycle limited by maximum $T_J$	1.4	mJ
Maximum power dissipation	$P_D$	$T_C = 25\text{ °C}$	657	W
		$T_C = 100\text{ °C}$	263	
Operating junction and storage temperature range	$T_J, T_{Stg}$		- 55 to + 150	°C

## ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	$V_{BR}$	$I_R = 100\text{ }\mu\text{A}$		400	-	-	V
Maximum forward voltage	$V_{FM}$	$I_F = 180\text{ A}$	See fig. 1	-	1.08	1.46	
		$I_F = 360\text{ A}$		-	1.22	1.8	
		$I_F = 180\text{ A}, T_J = 125\text{ °C}$		-	0.99	1.34	
Maximum reverse leakage current	$I_{RM}$	$T_J = 125\text{ °C}, V_R = 400\text{ V}$	See fig. 2	-	-	4	mA
Junction capacitance	$C_T$	$V_R = 200\text{ V}$	See fig. 3	-	370	500	pF
Series inductance	$L_S$	From top of terminal hole to mounting plane		-	6.0	-	nH

DYNAMIC RECOVERY CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time See fig. 5	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 135 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	90	140	ns
		T <sub>J</sub> = 125 °C		-	280	440	
Peak recovery current See fig. 6	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	9	16	A
		T <sub>J</sub> = 125 °C		-	18	32	
Reverse recovery charge See fig. 7	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	300	950	nC
		T <sub>J</sub> = 125 °C		-	2650	6300	
Peak rate of recovery current See fig. 8	di <sub>(rec)M</sub> /dt	T <sub>J</sub> = 25 °C		-	300	-	A/μs
		T <sub>J</sub> = 125 °C		-	290	-	

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 150	°C
Maximum thermal resistance, junction to case		R <sub>thJC</sub>	DC operation See fig. 4	0.19	°C/W
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.05	
Approximate weight				30	g
				1.06	oz.
Mounting torque	minimum			3 (26.5)	N · m (lbf · in)
	maximum			4 (35.4)	
Terminal torque	minimum			3.4 (30)	
	maximum			5 (44.2)	
Case style			HALF-PAK module		



HEXFRED®  
Ultrafast Soft Recovery  
Diode, 180 A

HFA180NH40PbF

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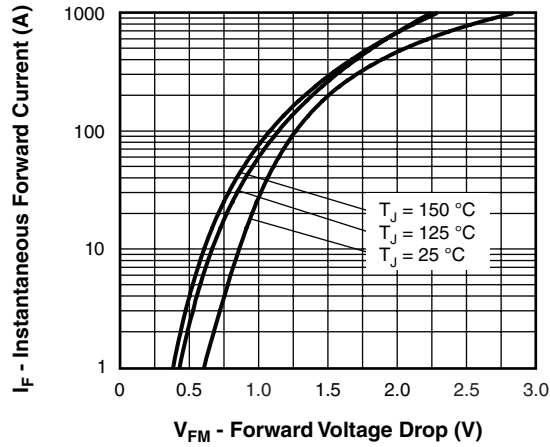


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

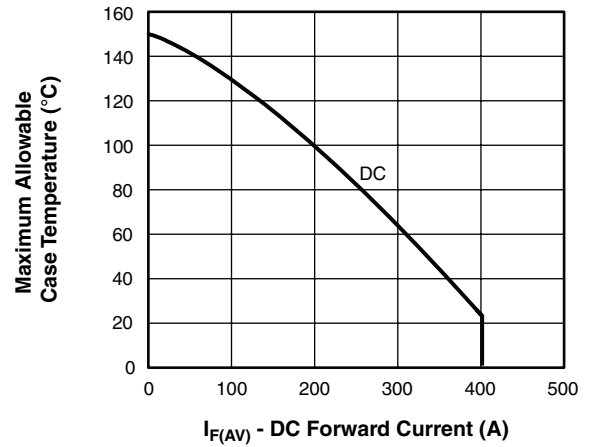


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current

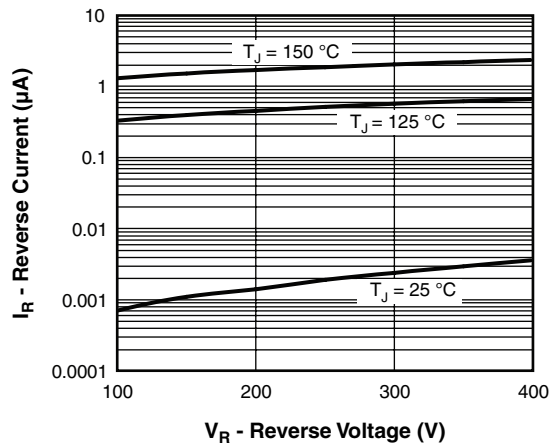


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

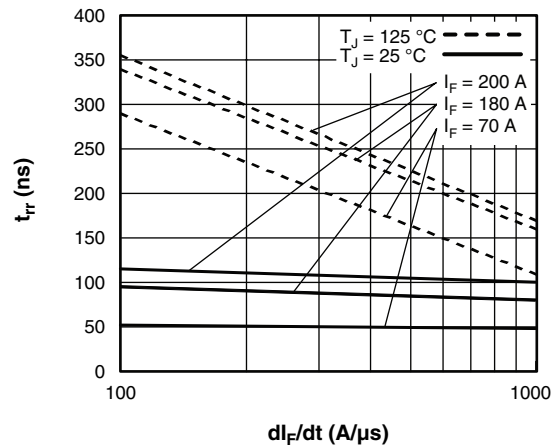


Fig. 5 - Typical Reverse Recovery Time vs.  $dI_F/dt$

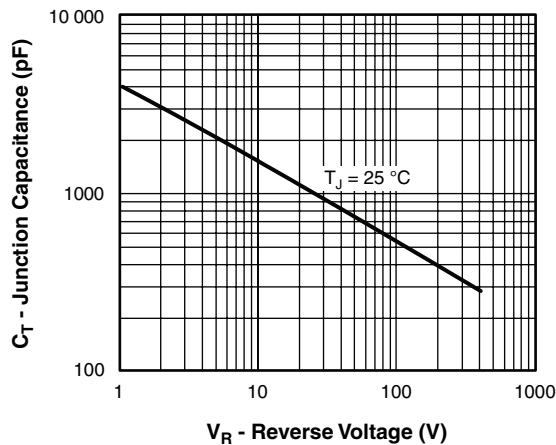


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

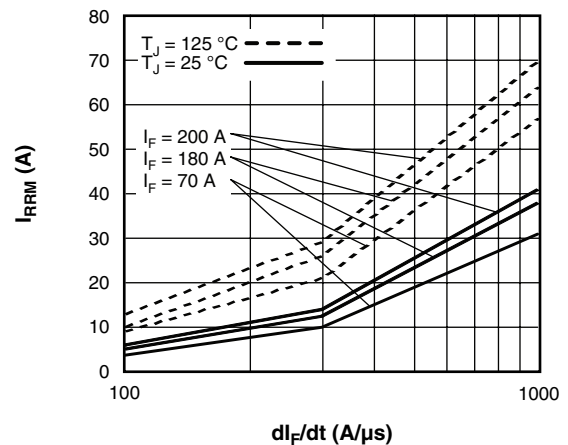


Fig. 6 - Typical Recovery Current vs.  $dI_F/dt$

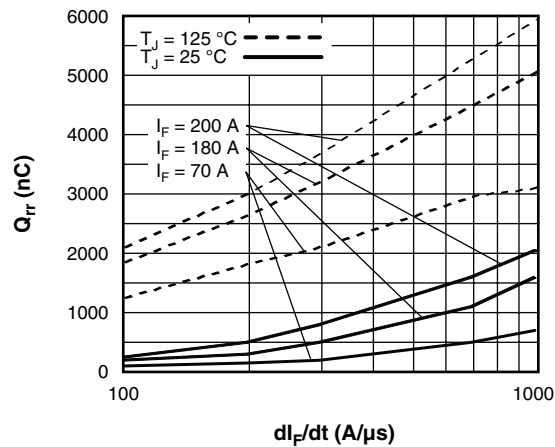


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$

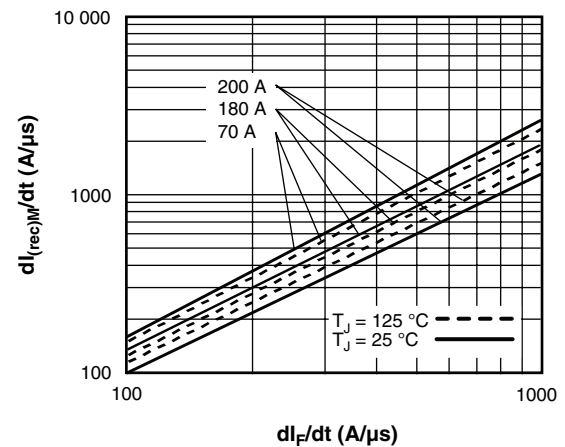


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$

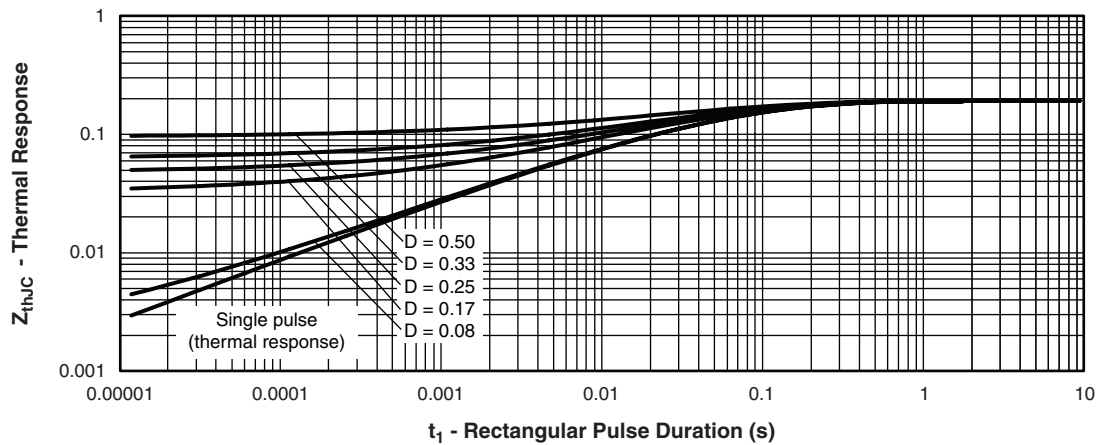


Fig. 9 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

## HEXFRED® Ultrafast Soft Recovery Diode, 180 A

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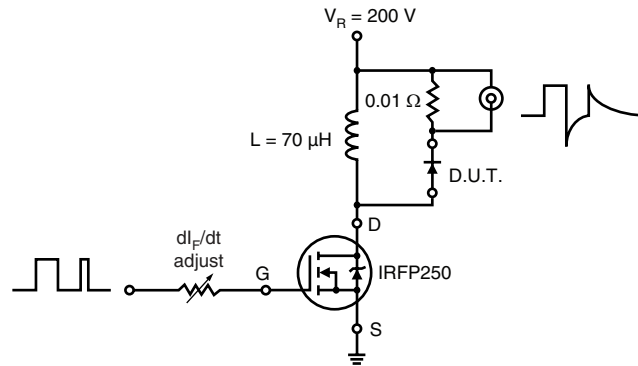
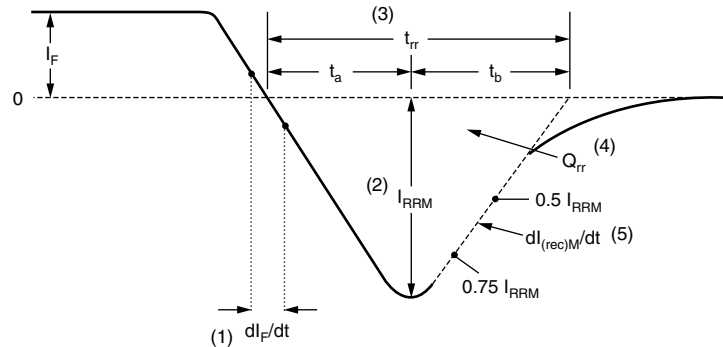


Fig. 10 - Reverse Recovery Parameter Test Circuit



(1)  $di_F/dt$  - rate of change of current through zero crossing

(2)  $I_{RRM}$  - peak reverse recovery current

(3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.

(4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 11 - Reverse Recovery Waveform and Definitions

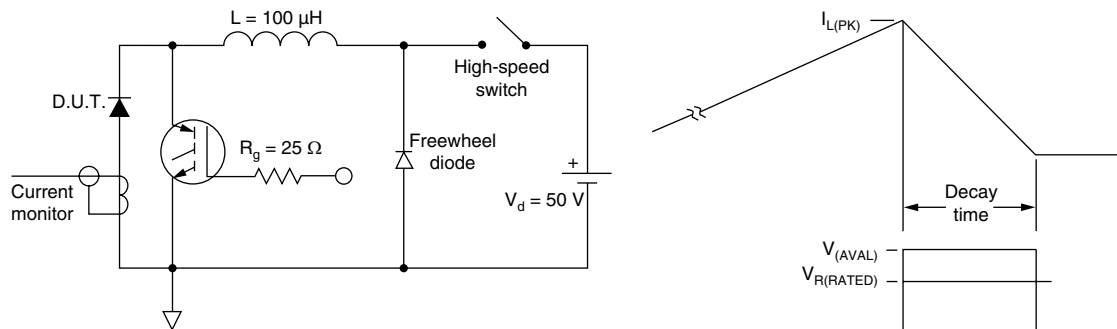


Fig. 12 - Avalanche Test Circuit and Waveforms

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## Device code

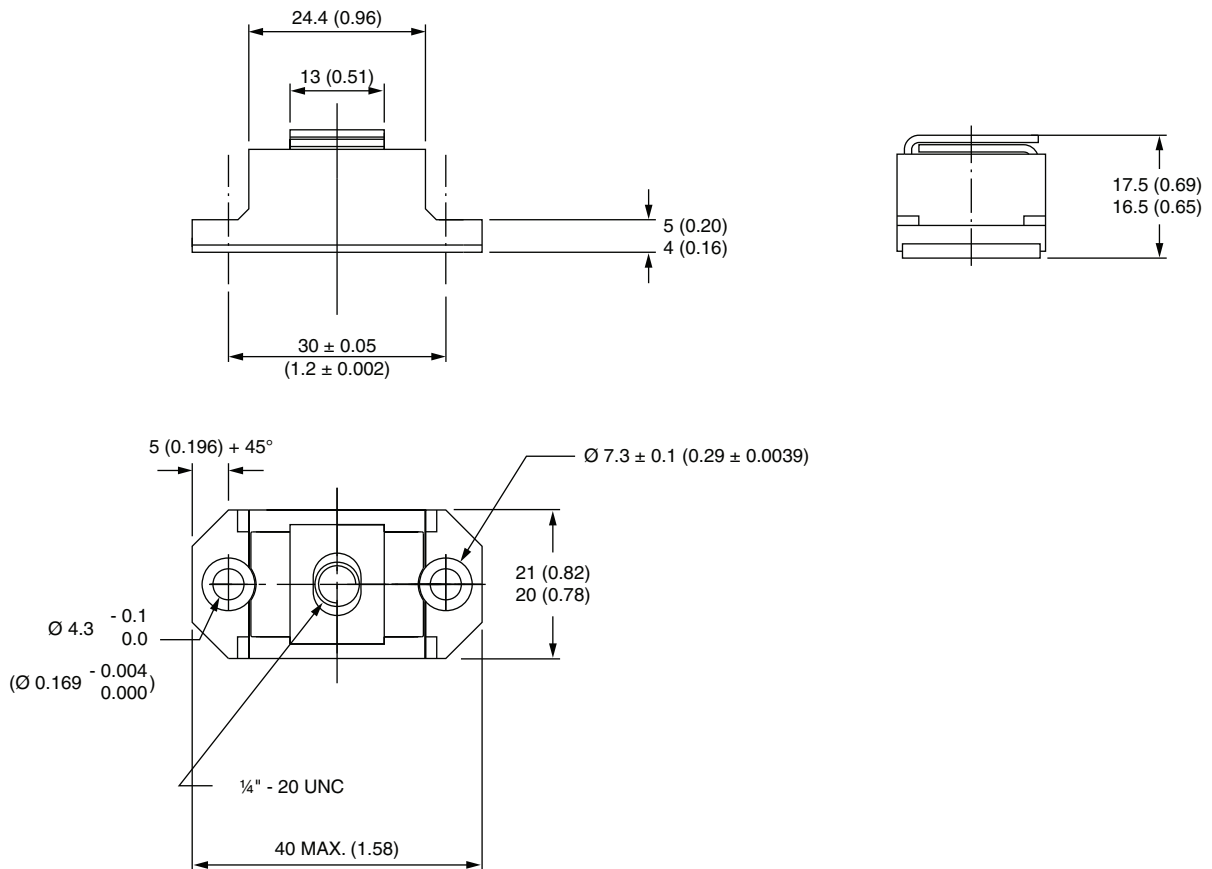
- 1** - HEXFRED® family, electron irradiated
- 2** - Average current rating
- 3** - N = Not isolated
- 4** - H = HALF-PAK
- 5** - Voltage rating (400 V)
- 6** - Lead (Pb)-free

## Dimensions

<http://www.vishay.com/doc?95020>

## D-67 HALF-PAK

**DIMENSIONS** in millimeters (inches)





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